



⁹ Ministry of Electronics & Information Technology Government of India



POST SHOW REPORT





Ministry of Electronics & Information Technology Government of India

India's Transformation into Emerging Tech, Industry 4.0, Mobile & Device Manufacturing Hub 2 August 2022 | New Delhi Hotel Le Meridien, Connaught Place - 110001

450+ delegates from electronics manufacturing (OEMs, EMS, supplier of equipment, PCB manufacturers, design companies, industry associations and Government organizations) participated



Inaugural Session

IPC collaborated with Federation of Indian Chamber of Commerce & Industry (FICCI) for organizing the Inaugural session of IEMI at Hotel Le Meridian New Delhi on August 2 - India's Transformation into Emerging Tech, Industry 4.0 & Mobile Manufacturing Hub. Mr. Hari Om Rai, Co-Chair, Mobile Manufacturing and Communications Committee FICCI and Chairman & Managing Director Lava International Ltd. Highlight of his presentation was India is making rapid strides in electronics production and has emerged as the second largest mobile phone manufacturing hub globally. In his Special Address by Mr. R.K. Pathak, Deputy Director General of Department of Telecommunications, Ministry of Communications, Government of India talked about making India a global hub for telecom equipment manufacturing and promote development of new standards to meet national requirements.

Dr John Mitchell, IPC President & CEO, will assessed the state of electronics manufacturing and identified the trends that will define the industry's financial growth and technological progress in 2022 and beyond. Touching on topics that are the focus of board rooms and shop floors: factory modernization, supply chain resiliency, workforce demands, and environmental stewardship, John covered ways to navigate organizations to succeed in today's dynamic global marketplace in his dynamic keynote, "Electronics Manufacturing Embraces Digital."

Panel discussion

With support from FICCI, group of invited specialists, exchanged their opinions on the stage with the help of Session Moderator from KPMG Mr Prasad Unnikrishnan on "India's Transformation into Emerging Tech, Industry 4.0, and Mobile & Device Manufacturing Hub Opportunities, Challenges & Way Forward". Panelists :

- Sanjay Huprikar President, Europe & South Asia Operations, IPC
- M. Thiyagarajan, President, Indian Printed Circuit Association (IPCA)
- Goh Yiu Jin, Member, Association of Electronics Industries in Singapore (AEIS)
- Vinod Sharma, Past President, Electronic Industries Association of India (ELCINA)
- Sandeep Narula, Chairman, Electronics & Software Export Promotion Council (ESC India)





Technical Session

Supported by

FICCI

Mr. Anup Wadhwa, Director, AIA in opening

presentation highlighted "An Ecosystem approach to Capability Building" and also pointed out Government of India's initiative towards Industry 4.0. Mr. Sunil Mehta, President, AIA and General Manager, Mitsubishi Electric India Pvt. Ltd presented on "Industrial Electronics Manufacturing scenario and its synergy with industrial automation". Mr. Ravi Managing Director Pepperl+Fuchs Agarwal, Factory Automation presented on "Simplifying the Smart Manufacturing

paradigm - experience sharing at FSM". Mr. David Bergman, Vice President (Standards & Technology) highlighted through his presentation "Factory of the Future", how IPC-2591 is enabling "plug and play" IoT communication across the manufacturing environment, where all equipment, manufacturing processes, and transactional stations can communicate without the need for specialized software.



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India - Emerging Aerospace Electronics Hub **4 August 2022 | Bengaluru**

Hotel Taj, Mahatma Gandhi Road, Yellappa Chetty Layout, Bengaluru 560001

500+ delegates from electronics manufacturing (OEMs, EMS, supplier of equipment, PCB manufacturers, design companies, industry associations and Government organizations) participated



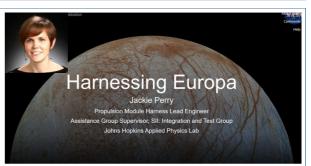
Inaugural Session

Dr. C.N. Ashwath Narayan, Honourable Minister, Higher Education, IT & BT, Science & Technology and Skill Development, Government of Karnataka was the Chief Guest at the IPC 10 years in India celebration event - Electronics Manufacturing & Interconnections (IEMI) at Bengaluru on August 4. In his address he talked about State of Karnataka, which has major potential to be the manufacturing hub for electronics, particularly aerospace. Government of Karnataka focusses on the Aerospace manufacturing ecosystem and 1,200-acre cluster is taking shape near the Kempe Gowda international airport. This will help organizations like ISRO, HAL, BEL to develop their vendors and supply chain. He highlighted that Department of IT, BT, Science & Technology;

is playing a key role to achieve the \$300 Bn digital economy target and is bringing the government and industry together. Karnataka has always been at the forefront leading the charge for technology space, contributing significantly to the country's digital growth. He congratulated IPC's skilling and certification initiative in India and assured cooperation from Government of Karnataka.

Technical Session

Jacklyn Perry, Johns Hopkins University Applied Physics Lab made virtual presentation on Harnessing Europa (a Jupiter-orbiting spacecraft) - NASA Project. Perry leads the team working on the Europa Clipper's propulsion module harness. Her group is responsible for ensuring that every component gets power and sends telemetry. Her presentation covered, "How will a spacecraft harness connect every electrical device on the Europa Clipper, a Jupiter-orbiting spacecraft that will study Jupiter's icy moon Europa"



Department of Electronics, IT, BT and S&T



Panel discussion

IPC organized panel session on "India: Emerging Aerospace Electronics Hub Opportunities, Challenges and Way Forward". Mr. M Sankaran, Director, UR Rao Satellite Center (URSC) moderated the panel session. The Panel Members:

- Wg Cdr Venugopal Menon (Retd), Hon. Secretary, Society of Indian Aerospace Technologies & Industries (SIATI)
- Wg Cdr Rachit Bhatnagar, CEO, Aerospace & Aviation Sector Skill Council (AASSC)
- Shripathi V, Member of Association of Electronic Industries in Singapore (AEIS)
- J Krishna Kumar, Scientist "F", Regional Director RCMA (APS), Member of CEMILAC, DRDO
- David Bergman, VP, Standards & Technology, IPC



	Company	Countries	200+ B2B meetings
	Holy Stone Holdings(S) Pte.Ltd.	Singapore	Held at IEMI New Delhi on August 2 &
	DYNACAST	Singapore	0
	HIBEX	Singapore	Bengaluru on August 4 with the
	Interflux Singapore Pte. Ltd.	Singapore	international delegates Indian
	Inout Enterprise Pte. Ltd.	Singapore	0
-	American Tech	Singapore	representation from electronics
9	McCoy Pte. Ltd.	Singapore	manufacturing (OEMs, EMS, supplier of
3	Marrath Trading and Contracting	Qatar	
1	Airbus	UAE	equipment, PCB manufacturers, design
	GPV Lanka (Pvt.) Ltd.	Srilanka	companies)
and a	Flintec Transducers (Pvt.) Ltd.	Srilanka	somparios,

Company	Product/Services
JAPAN UNIX	Soldering automation, peripherals
ISRO	Models of satellite, spacecraft, launchers
JBC	Soldering automation, peripherals
NANOTECH - TMI	Automation, EV, HVAC, Analytical Test & Measurement Solution
Static Systems	Electric fencing, metal detectors, entrance automation, polescan, security prods.
Anritsu	Test, accessories, optical sensing
Mectronics	SMT materials, cleaning, coating materials & tools, thermal profiling
EFY Group	Electronics & Technology digital & print publication
Advance Tech	Soldering, de-soldering, screw assembly, test & measurement, ESD, solutions
Hakko Japan/Sumitron	Soldering/de-soldering, rework solutions
Peninsula Electronics	Quality products and services to aviation, space, defense and allied sectors
EMI Solutions	Test, accessories, optical sensing
AEIS	Association of Electronics Industries in Singapore
Ray-Q Interconnect	EWIS components and harnesses for industrial applications
Carl Zeiss	Reliable, high-quality measuring technology
HTL Ltd.	Optical fiber cables & component, connectivity & wiring interconnect solutions

20+ Exhibitors

Showed up with their products and services in the IEMI events at New Delhi & Bengaluru



Award Program

On the occasion of IPC 10 years celebration event, Dr John Mitchell, IPC President & CEO presented award to Indian Electronics Manufacturing Members companies engaged with IPC educational resources during last decade.

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	Patnership forever	Micropack Private Limited	ROSSELL TECHSYS And the fact and the fact the		BURCA SCARENGRAREN BURAT ELECTRONICS	SFO TECHNOLOGIES A NeXT Group Company CREATING INNOVATIVE SOLUTIONS
	PHILIPS	ADDI AMERICAN DISTRIBUTORS LLC Coppere Statistic - Logistic Statistics	CYIENT	BARCO	Centum Electronics Limited	GOODRICH

Global Volunteer of the Year (2020 - 2021) award were presented to



Lalith Bandara Manager – Learning and Development GPV Group, Sri Lanka







Amba Prasad Tejas Networks India





The initiative supports the drive for the "Skilling India" mission of the Government of India and promotes specialized skill development in the electronics manufacturing industry.

Preliminary Round

It was the first time that IPC India brought the skill challenge competition on #HandSoldering #WireHarness #PCBdesign to Member premises to allow maximum participation from employees. A total of 100+ companies and 1500+ employees participated in the first round of the competition, which was played at various company locations in India between January and April 2022. Three best performers were chosen by the company for participating at semi-final round. Observations were conducted virtually or in person according to the guidelines of the expert committee. Wire harness and hand soldering schematics were prepared in accordance with IPC standards. The PCB Design competition was organized offline by providing guidelines, schematics, BOMs, and mechanical specifications.

ARYA- EMBEDDED SOLUTIONS	ASHIDA	CLASSIC STRIPES	COMMSCOPE" now meets next	G GIC	UNO(MINDA)	PHILIPS	Schlumberger
	SIEMENS	sedemac™	VCB	(A) AERO REL SYSTEMS	🚫 Eruvaka	SMART-WAVES	
R R105	Electro Circuit Systems	OROSSELL TECHSYS		AMP®	ALPHA DESIGN TECHNOLOGIES	CISGLOBAL	Ray-Q Interconnect
EXCELUNCE DELIVERED		SASTION	SGS Tekniks	A BOLUTION PROVIDER A SOLUTION PROVIDER ASSING Cented Organisation		Visteon	Avalon
India Nippon Electricals Ltd	Salcomp	e-con Systems"	🕅 BorgWarner	BHARAT ELECTRONICS QUALITY: TECHNOLOGY, INNOVATION.	Powering Business Worldwide	HTL Ltd.	VINROX
PAI			VISTA	Mahindra TELEPHONICS	E.I.S.	LohiaCorp	\$\$\$
<i> Exicom</i>	Valeo	Precision			Adapt - EVOLVE - PROGRESS	exicom	(A) AERO REL SYSTEMS
ROSSELL TECHSYS	CREATING INNOVATIVE SOLUTIONS	molex®	CYIENT	KRYPTON SOLUTIONS	CALPHA DESIGN TECHNOLOGIES PVT. LTD.	Smart WAVE Technologies	Securing your Future with your own Hands
SPC	CRUS	MISTRAL Pavilors in Real Time	SIENNA ECAD Design . Enhance . Verify	Electro Circuit Systems	CENTUM entum Electronics Limite	AMP	🕅 BorgWarner

and many more...









Semi Final Round



Pune Hyderabad Chennai Ahmedabad Bengaluru Dubai (UAE) Colombo (Sri Lanka) New Delhi

Candidates chosen from preliminary rounds played semi-final rounds at different locations in India during May - July 2022, including Colombo (Sri Lanka) and Dubai (UAE). IPC India was successfully able to organize such events in different cities across India with the support of the electronics industry associations (MCCIA, TELMA, ELCIA, SICCI, GEZIA & ELCINA). Workshops and networking events were organized during the sessions to raise awareness about skill development. In New Delhi on August 2, the semi-final round of the North Region was held as part of the IPC's 10 years celebration event - Integrated Electronics Manufacturing & Interconnections (IEMI).

Final Round



On August 4, Integrated Electronics Manufacturing & Interconnections (IEMI) was held at Bengaluru as part of IPC's 10 years anniversary celebration of India. Competitors participated in the final round of the skill challenge competitions were winners and runners-up from each semi-final zone, including Sri Lanka and the UAE. During the awards program, winners and runner ups were announced for Hand Soldering, Wire Harness & PCB Design Competition:

• **#Handsoldering Winner** – Ranganath H from Cyient DLM and **Runner Up** – Rakshit Gowda of Automat Electronic Services, UAE. They will be participating at IPC world hand soldering competition to be held in Munich, Germany during 15-17 November 2022

• #Wireharness Winner – Amit Kumar from Vista Consoles Electronics Pvt Ltd and Runner Up – Babu Kumar from BEL

• **#PCBDesign Winner** – Satish Kumar Vijay Kumar from Tessolve Semiconductor Pvt. Ltd and **Runner Up** – Harish.G from Exicom Tele Systems.





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Glimpses of IPC 10 Years celebration in India





Integrated Electronics Manufacturing & Interconnections 2022

THANK YOU Supporting Partners



Please Talk To Us

IPC India Regional Headquarters

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